**Material Set Change:**

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| --- | --- | --- |
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| Package Material Set | Carsem | ASE Chungli |
| 8L and 10L MSOP | Die Attach | Ablestik 84-1 LMISR4Hysol QMI519 | Hitachi EN4900 |
| Mold Compound  | Sumitomo 6600HHitachi CEL8240HF10LXSumitomo G600 | Sumitomo G700  |
| Wire | Tanaka GLD 4N Gold 1milTanaka M3 4N Gold 1milTanaka M3 Gold 1mil | Heraues Relmax 2N Au 1milTanaka GPG – 2N AU 0.8mil |